

Standard Product Specifications

FY1101C-2005-M-TR

Features

Package	1608 Flat lens type, water clear resin, sorted by forward current 5mA
Product features	• Outer dimension 1.62 x 0.8 x 0.8mm (L x W x H) • Lead-free soldering compatible • RoHS2 compliant

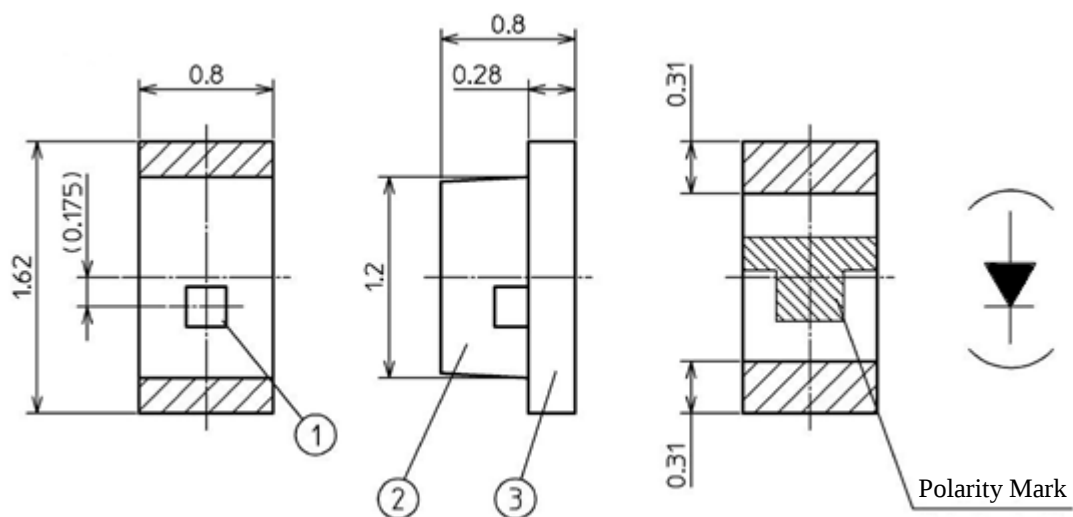
Recommended Applications

- Amusement machine, Home appliances, OA/FA use, Various indicators, etc.

Outline Dimensions

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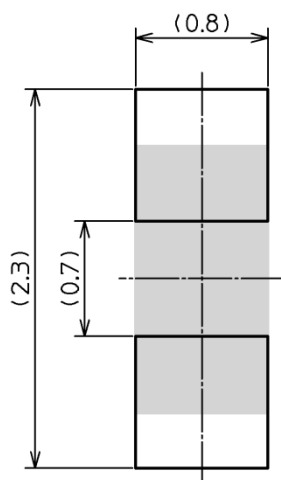
Unit : mm
Weight : 1.8mg
Tolerance : ± 0.1



NO.	PART NAME	MATERIAL	QTY.
①	LED die	AlGaInP	1
②	Mold resin	Epoxy resin	1
③	Substrate	Glass fabrics	1

Recommended Pad

Unit : mm



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【 Absolute Maximum Ratings 】

(Ta=25°C)

ITEM	SYMBOL	MAXIMUM RATINGS	UNITS
Power Dissipation	Pd	81	mW
Forward Current	I _F	30	mA
Repetitive Peak Forward Current "Pulse width ≤ 1ms, Duty ≤ 1/10"	I _{FRM}	100	mA
I _F Derate Linearly from "25°C"	ΔI _F	0.43	mA/°C
I _{FRM} Derate Linearly from "25°C"	ΔI _{FRM}	1.00	mA/ °C
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +100	°C
Soldering Temperature "Reflow Soldering"	T _{sld}	260	°C

Note1

Note1 Please refer to page 8, Soldering conditions.

【 Electro and Optical Characteristics 】

(Ta=25°C)

ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Forward Voltage	V _F	I _F = 5mA	-	1.9	2.4	V
Reverse Current	I _R	V _R = 5V	-	-	100	μA
Luminous Intensity	I _v	I _F = 5mA	10	20	64	mcd
Peak Wavelength	λ _p	I _F = 5mA	-	592	-	nm
Dominant Wavelength	λ _d	I _F = 5mA	581.5	590	597.5	nm
Spectral Line Half Width	Δλ	I _F = 5mA	-	15	-	nm

Note2

Note2 : Sorting Tolerance: ±10%

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【 Sorting For Luminous Intensity and Dominant Wavelength 】

LED's shall be sorted out into the following ranks of Luminous Intensity and Dominant Wavelength.

Luminous Intensity (I_v) Rank

Rank	I_v (mcd)		Conditions
	MIN.	MAX.	
B	10	16	$I_F=5mA$ $T_a=25^{\circ}C$
C	16	25	
D	25	40	
E	40	64	

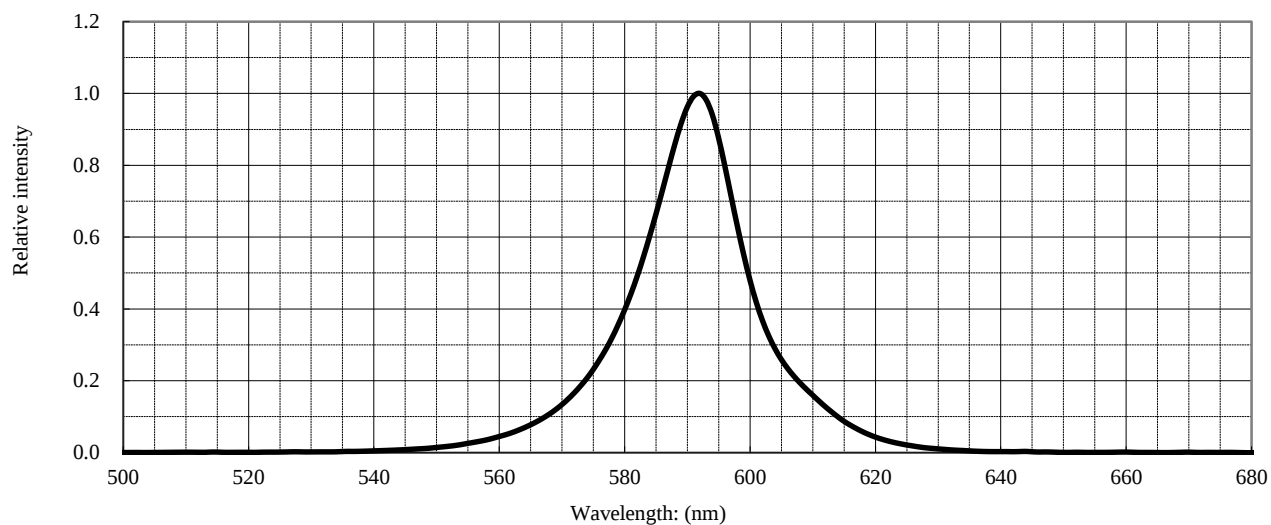
Dominant Wavelength (λ_d) Rank

Rank	λ_d (nm)		Conditions
	MIN.	MAX.	
A	581.5	585.0	$I_F=5mA$ $T_a=25^{\circ}C$
B	584.0	587.5	
C	586.5	590.0	
D	589.0	592.5	
E	591.5	595.0	
F	594.0	597.5	

Notes : Sorting Tolerance: $\pm 10\%$

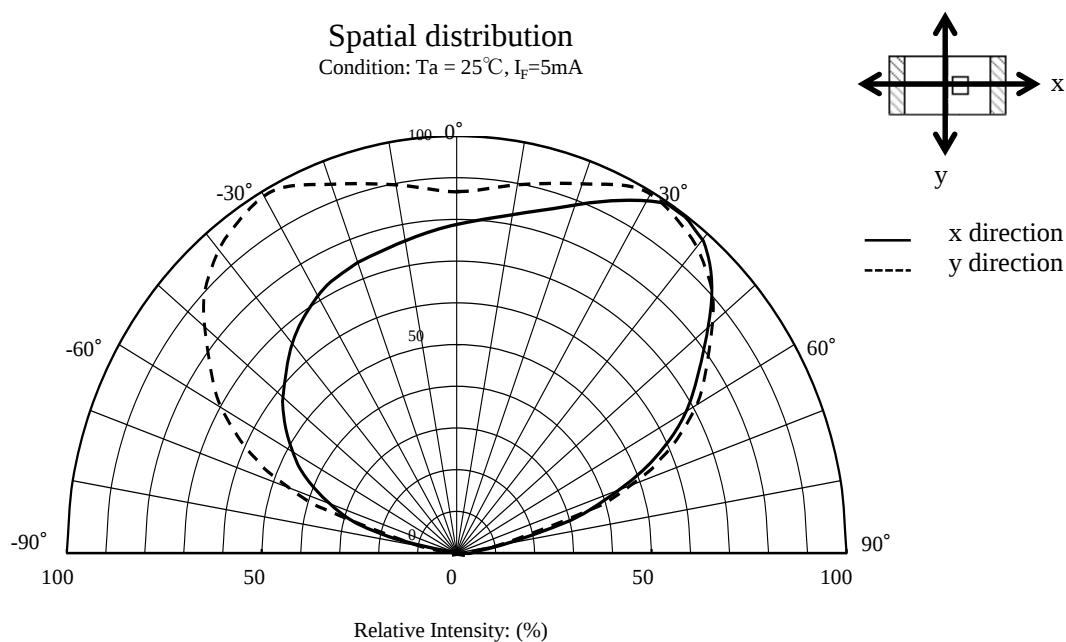
Wavelength vs. Relative intensity

Condition: $T_a = 25^\circ\text{C}$, $I_F = 5\text{mA}$



Spatial distribution

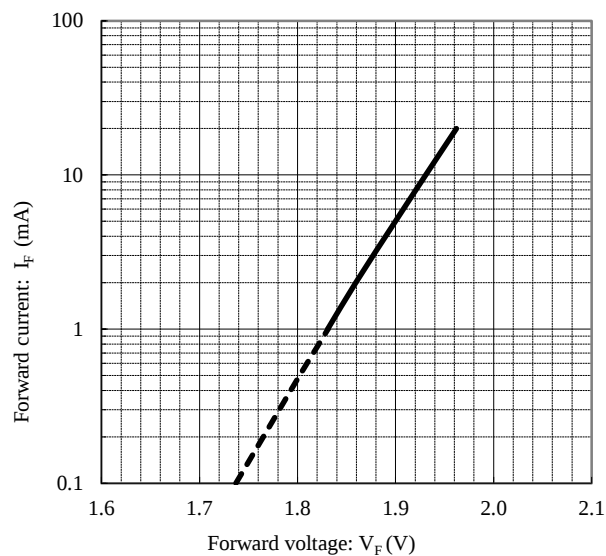
Condition: $T_a = 25^\circ\text{C}$, $I_F = 5\text{mA}$



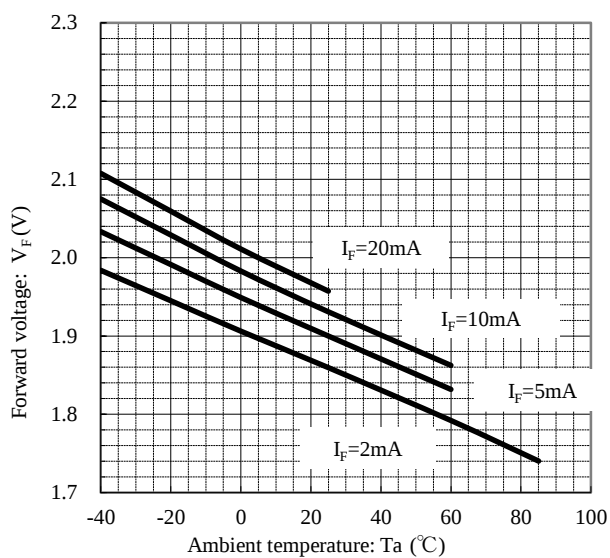
Technical Data

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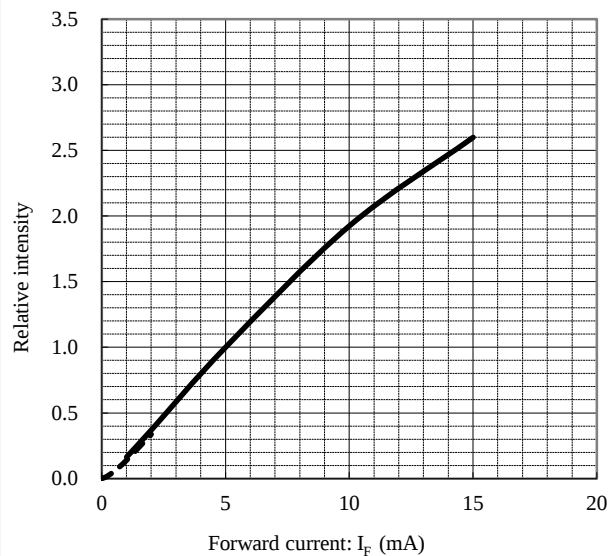
Forward voltage vs. Forward current

Condition : $T_a = 25^\circ\text{C}$ 

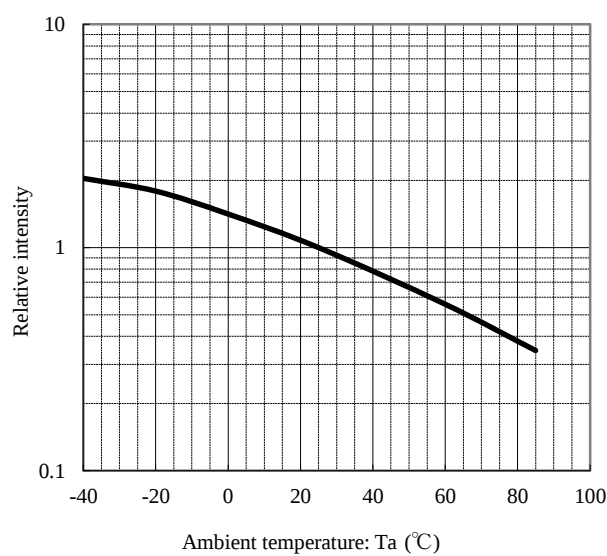
Ambient temperature vs. Forward voltage

Condition: $I_F = 2$ to 20mA 

Forward current vs. Relative intensity

Condition: $T_a = 25^\circ\text{C}$ 

Ambient temperature vs. Relative intensity

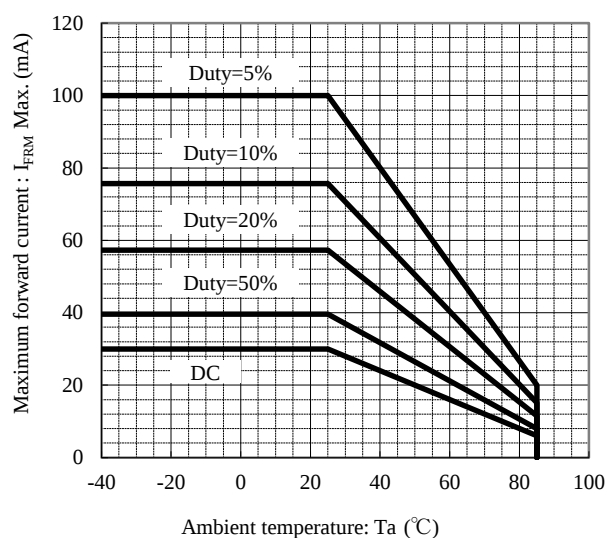
Condition: $I_F = 5\text{mA}$ 

Technical Data

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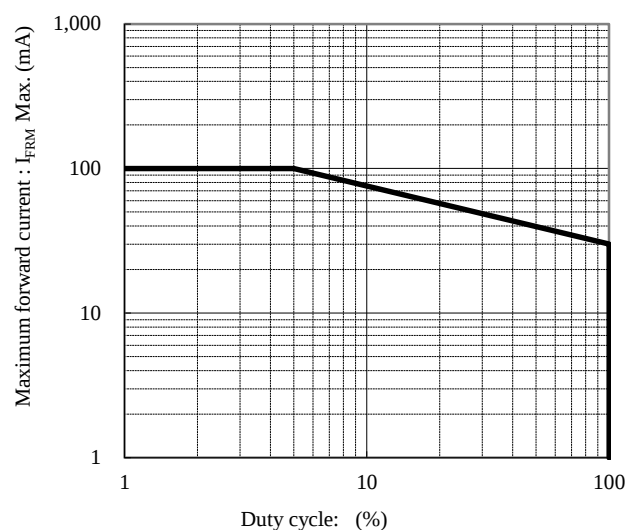
Max. forward current vs. Ambient temperature

Repetition frequency: $f \geq 50\text{Hz}$



Max. forward current vs. Duty cycle

Condition: $T_a = 25^\circ\text{C}$

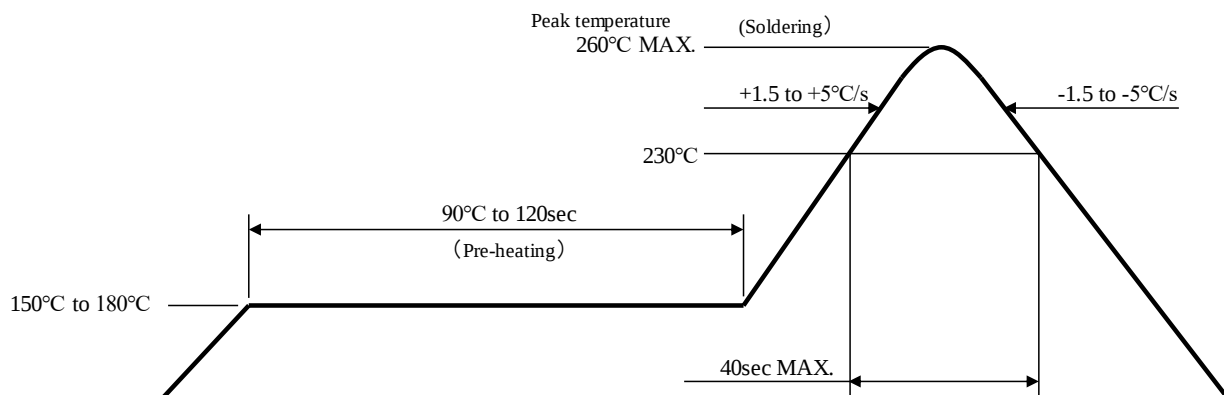


Soldering conditions

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1. Reflow Soldering

【Recommended reflow soldering condition】



1. The above temp. profile shall be at the surface of LED resin.
2. The number of reflow process shall be 2 time MAX. If second reflow process would be performed, intervals between first and second process shall be as short as possible to prevent absorption of moisture to resin of LED. Cooling process to normal temp. shall be required between first and second reflow process.
3. Temp. fluctuation to LED at pre-heat process shall be minimized.

2. Manual Soldering (Soldering iron)

Temperature of Iron Tip	350°C MAX.
Soldering Duration, Time	3sec. MAX., 1 time

※ The number of manual soldering process shall be 1 time.

3. Other Caution

1. As manual soldering, please heat the solder pad, should not contact a tip of iron to a product (especially resin).
2. Heat or UV(or both) curing resin shall used for preliminary fixing.
Curing condition temp. : 150 °C MAX. , time : 120s MAX.
3. After soldering, any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp.

Handling Precaution

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1. Cleaning

- Special care shall be taken when applying the chemicals listed below for cleaning because certain chemicals may damage the surface of lens or care and cause discoloration.

Cleaning agents	Recommended / Not recommended
Isopropyl alcohol	✓ Recommended
Ethyl alcohol	✓ Recommended
Pure water	✓ Recommended
Trichloroethylene	x Not recommended
Chloroethene	x Not recommended
Acetone	x Not recommended
Thinner	x Not recommended

- ※ Dipping time is 3minutes MAX. (In normal temp.)
- ※ It can be cleaned on the next page conditions, about pure water.

- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of P.C.B. and LED mounting method. So the use of ultrasonic cleaning is strongly recommended after confirming that there is no problem.
- When using Freon equivalent solvent, discoloration on the LED surface may be caused by one of the first confirming that there is no problem.
 - ※ Freon substitute detergent
 - Clean through 750H
 - Pine alpha ST-100S
- In the case of water-washing , ensure to use pure water (not tap water) and immediately after the washing is over, apply forced drying to remove all the moisture from the LED.

2. Warrant period

- Within 6 month by following conditions.
Un-opened, +5 to +30°C / 70% MAX.

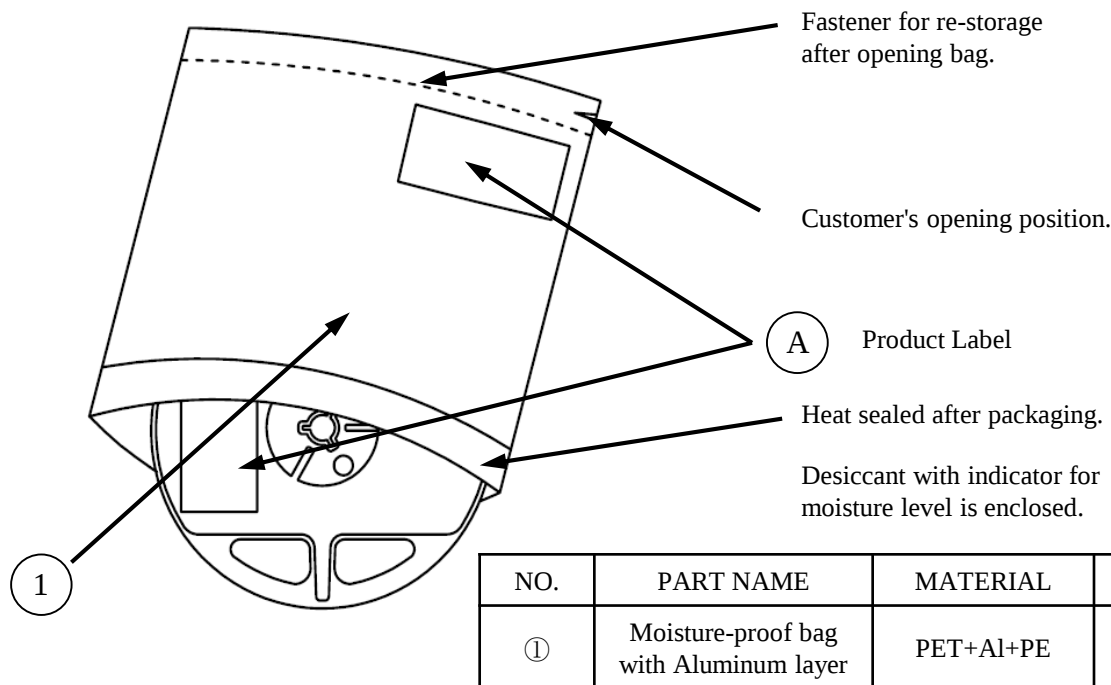
3. Handling after opened

- In case of no-using promptly or on the way to using, LEDs should be restored following conditions and the bag should be fastened the zip lock to prevent absorption of moisture to resin of LEDs.
+5 to +30°C/ 70% MAX.
- Unpacked LEDs should be stored under the following conditions.
LEDs must be soldered on board within 72h whether they are restored in the bag or not.
+5 to +30°C / 70% MAX.
- In any case **over 72h has past after opening** the bag or the indicator color of the desiccant has changed(Blue→Pink), baking should be performed under the following conditions.
+60±5°C, 10 to 12 hours

【 Other Precautions 】

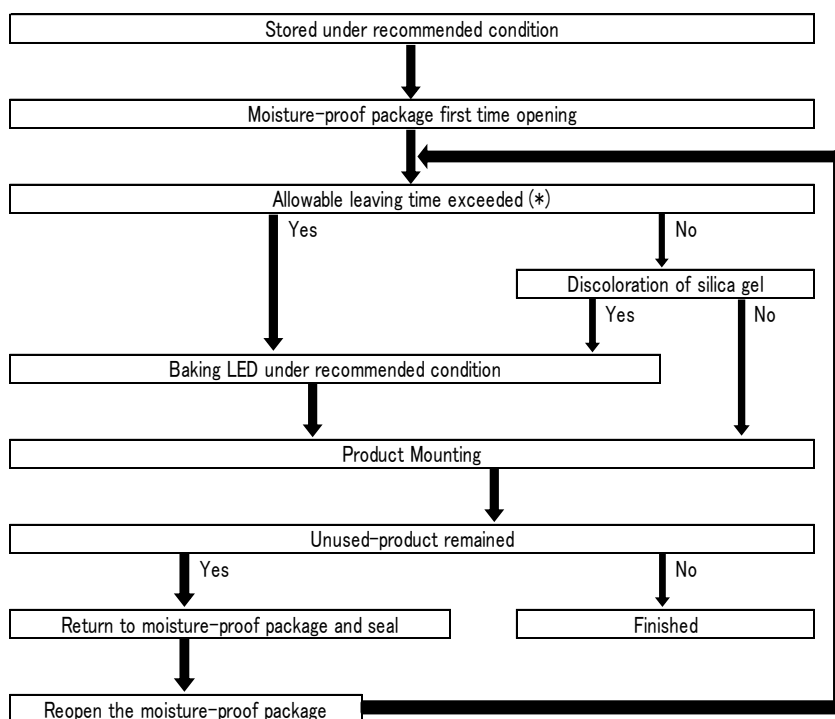
1. The products are designed to achieve higher performance reliability, however, they can be influenced by usage conditions.
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. (Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert protective resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
6. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
7. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
8. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
9. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
10. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

【Moisture-proof Packaging Specification】



2. Packaging Box Specifications

Flow Chart-package Opening to Mounting 8



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated from the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated from the first opening of package, or from the time when baking process is finished.

Packaging Specifications

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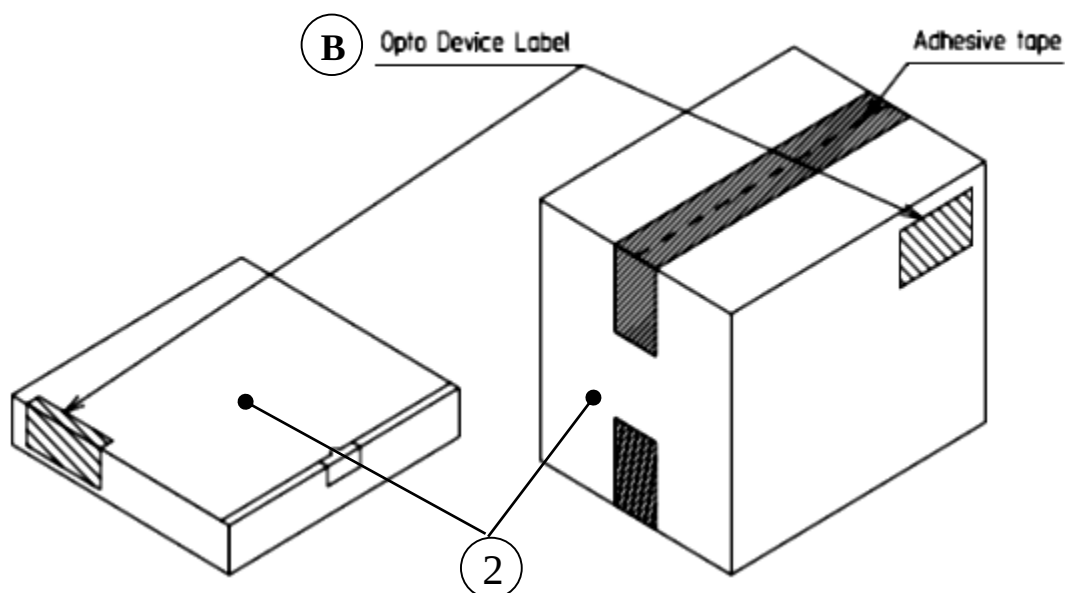
【 Packing box 】

(RoHS•ELV Compliant)

Box TYPE	Outline dimension L x W x H (mm)	Capacity of the box
Type A	280 x 265 x 45 (mm)	3 reels
Type B	310 x 235 x 265 (mm)	15 reels
Type C	440 x 310 x 265 (mm)	30 reels

The above measure is all the reference value.

The box is selected out of the above table, by the shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B,C

Material / box : Cardboard K5AF

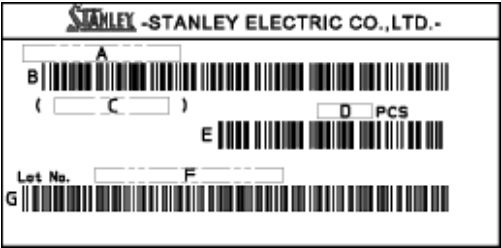
Partition : Cardboard K5BF

NO.	PART NAME	MATERIAL	REMARKS
②	Packing Box	Corrugated Cardboard	without ESD protection

【 Label Specification】

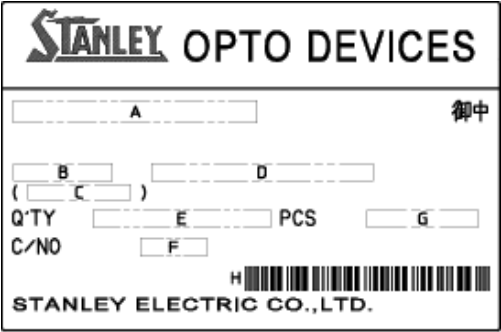
(acc.to ; JIS-X0503(Code-39)

A Product label



- A. Parts number (Indicated the whole parts number)
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity (Indicated Parts Qty in the packing)
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank (indicated the following 16 digits)
- G. Bar-Code for Lot number & Rank

B Opto device label



- A. Custmer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

<Remark> Bar-code font : acc.to Code-39(JIX0503)

Lot Number Notational System

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①	②	③	④	⑤	⑥	⑦	⑧	⑨							

① - 1digit : Production Location (Mark identify alphabet)

② - 1digit : Production Year (Last Digit of Production Year 2025→5, 2026→6, 2027→7, 2028→8····)

③ - 2digits : Production Month (Jan. to Sep. ,Should be 01,02,03,·····)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

⑦ - 2digits : Luminous Intensity Rank. (If only 1 digit, second digit must be dash "-"and if not identified rank, its"- -")

⑧ - 2digits : Chromaticity Rank (If only 1 digit, second digit must be dash "-"and if not identified rank, its"- -")

※Special rank identification such as Y',A' rank must be "YY" or "AA", not using prime "′"

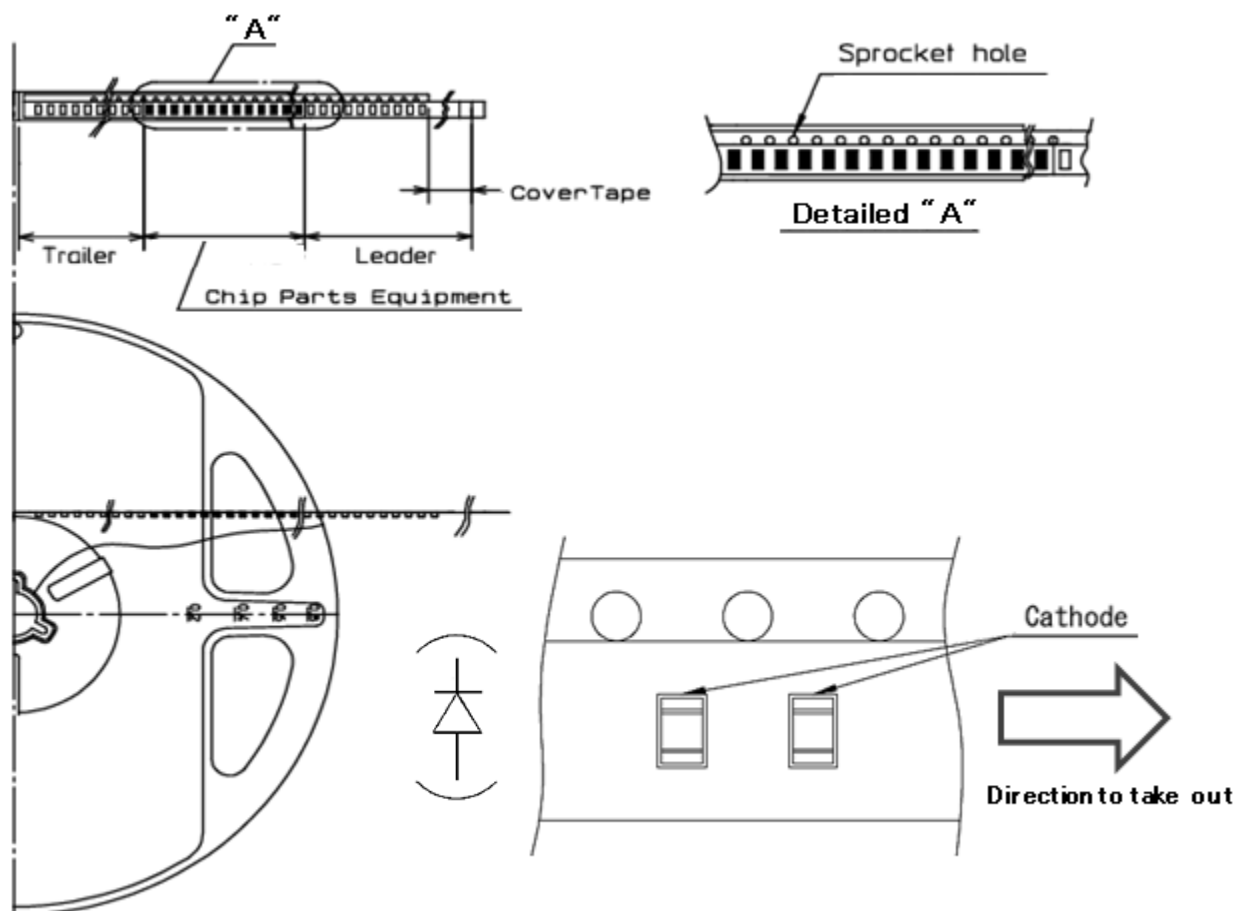
⑨ - 1digit : Option Rank (Normally its"-")

Taping and Reel Specifications

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(acc.to ; JIS-C0806-03)

1. Appearance



Note

"-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 200mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 10 pieces.	Please refer to the above figure for Taping & reel orientation.
Trailer area		Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.

Taping and Reel Specifications

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2. Qty. per Reel

4,000 pcs./reel

3. Mechanical strength

Cover-tape adhesive strength shall be 0.1 to 1.0N (An angle between carrier-tape and cover-tape shall be 170 deg.) Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

4. Others

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held.

No more than 1 connecting empty pockets of taping.

Empty Pocket per reel is assumed until 5piece.

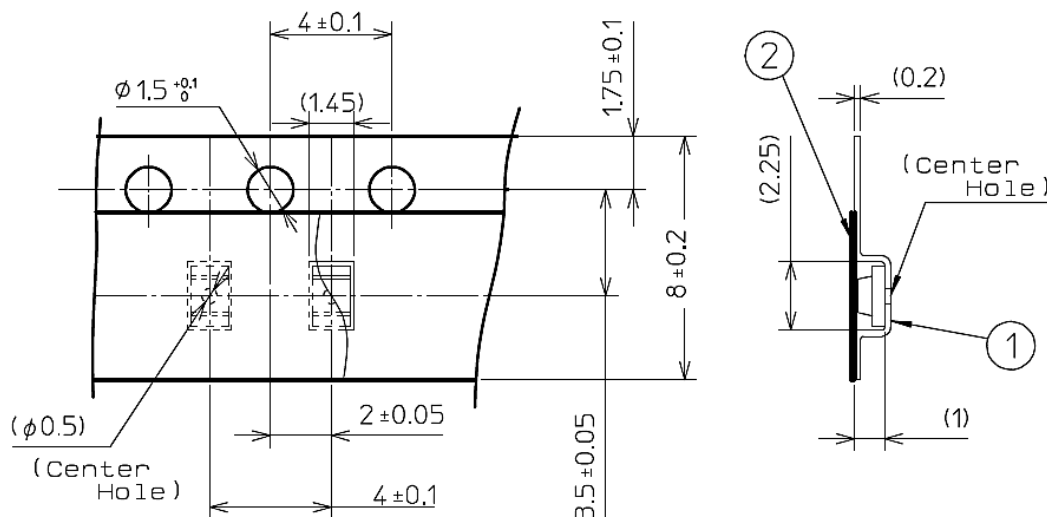
Taping and Reel Specifications

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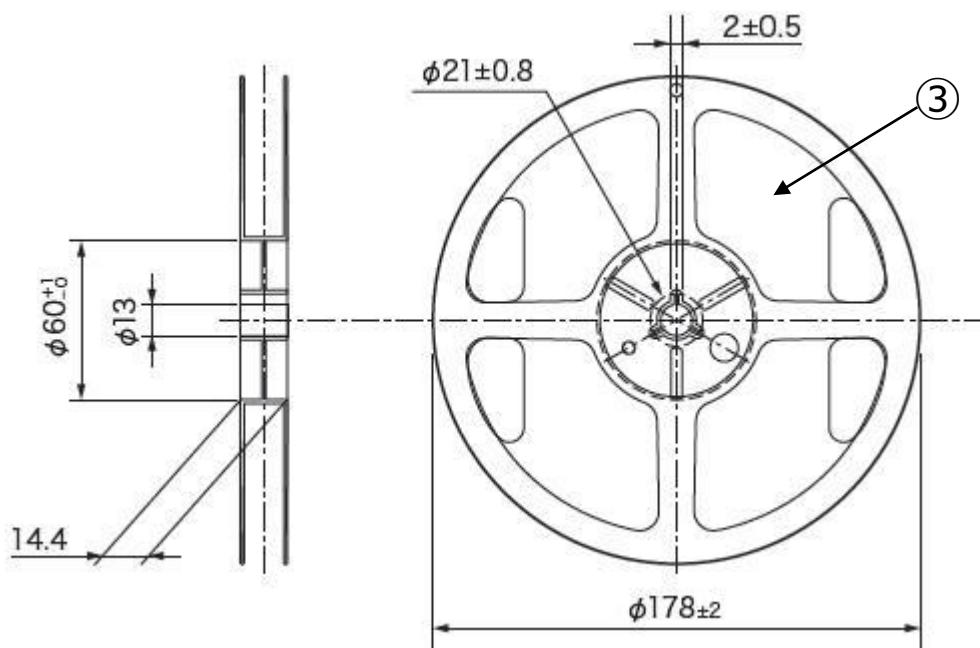
Unit : mm

(acc.to ; JIS-C0806)

5. Taping Dimensions



6. Reel Dimensions



No.	Part name	Remarks
①	Carrier-tape	Anti-static grade
②	Cover-tape	Anti-static grade
③	Carrier-reel	Conductive grade

Correspondence to RoHS2 / ELV instruction

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This product is in compliance with RoHS2 / ELV.

Prohibition substance and its criteria value of RoHS2 / ELV are as follows.

- RoHS2 instruction ... Refer to following 1 to 10.
- ELV instruction ... Refer to following 1 to 4.

2011/65/EU, (EU)2015/863

No.	Substance group name	Maximum permissible concentration value
1	Lead and its compounds	1,000ppm (0.1%)
2	Cadmium and its compounds	100ppm (0.01%)
3	Mercury and its compounds	1,000ppm (0.1%)
4	Hexavalent chromium compounds	1,000ppm (0.1%)
5	PBB : Polybrominated Biphenyls	1,000ppm (0.1%)
6	PBDE : Polybrominated Biphenyl Ethers	1,000ppm (0.1%)
7	DEHP : Bis (2-ethylhexyl) phthalate	1,000ppm (0.1%)
8	BBP : Butyl benzyl phthalate	1,000ppm (0.1%)
9	DBP : Dibutyl phthalate	1,000ppm (0.1%)
10	DIBP : Diisobutyl phthalate	1,000ppm (0.1%)

Reliability Testing Result

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Reliability testing items	Testing conditions	Duration	Failure
Room temp. operating life	Ta = 25°C, If = 30mA	1,000 h	0/20
Resistance to soldering heat	Pre-heating : 150 to 180°C 90 to 120s Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	2times	0/20
Temperature cycling	-40°C (30min) to Normal temperature(15min) to +100°C (30min) to Normal temperature(15min)	5 cycles	0/20
Wet high temp. storage life	Ta = 60±2°C, RH = 90±5%	1,000 h	0/20
High temp. storage life	Ta = +100°C	1,000 h	0/20
Low temp. storage life	Ta = -40°C	1,000 h	0/20
Vibration, variable frequency	98.1m/s ² (10G), 100 to 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous intensity	I _v	5mA	Testing Min. Value < Spec. Min. Value x 0.5
Forward voltage	V _F	5mA	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse current	I _R	5V	Testing Max. Value ≥ Spec. Max. Value x 2.5
appearance	-	-	Occurrence of notable discoloration, deformation and cracking

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